

# Development of low noise and high speed SWIR receivers

**Xiaogang Bai**, Ping Yuan, Paul McDonald, Joseph Boisvert,  
Robyn Woo, Kam Wan, Rengarajan Sudharsanan  
Boeing Spectrolab Sylmar, CA

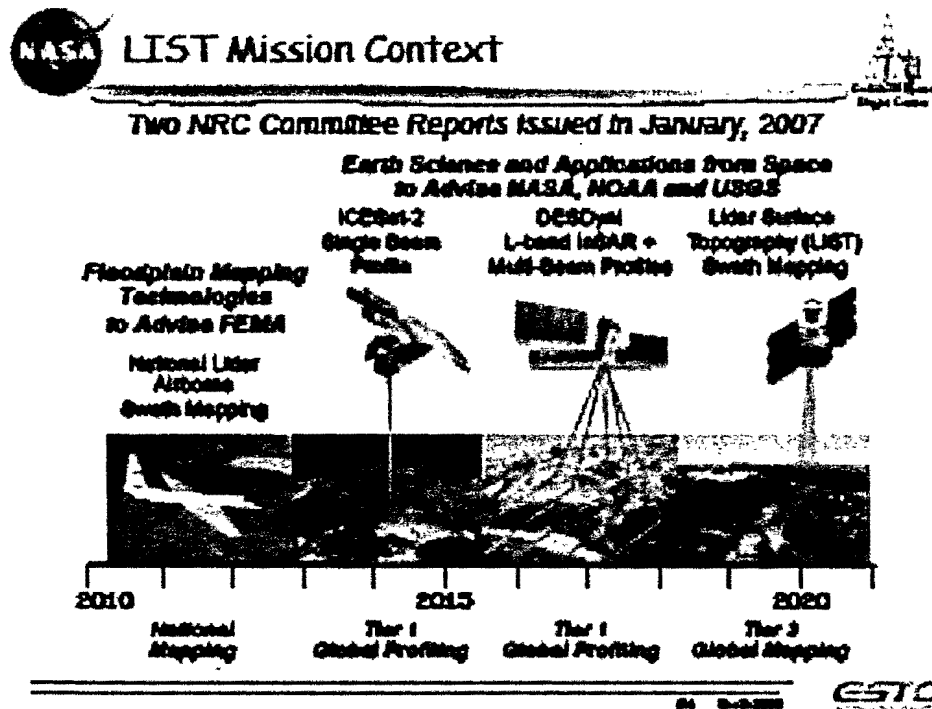
Michael Krainak, Guangning Yang, Xiaoli Sun, Wei Lu  
NASA Goddard Space Flight Center, MD

Dion McIntosh, Qiugui Zhou, Han-din Liu, Joe Campbell  
Dept of ECE, University of Virginia, VA

- Motivation
- Receiver Requirements
- Gen.1 photoreceiver design and performance
- Gen. 2 design and receiver development
  - $I^2E$  low excess noise APD design
- Summary

# Motivation

- Low-noise high speed receivers operating in the 1-1.5 micron wavelength region are needed for future NASA LADAR imaging applications
- Currently LADAR receivers use Si APD detectors with sensitivity as low as  $40 \text{ fW/Hz}^{1/2}$  for many NASA applications
  - Si detectors are limited to only in the visible spectrum



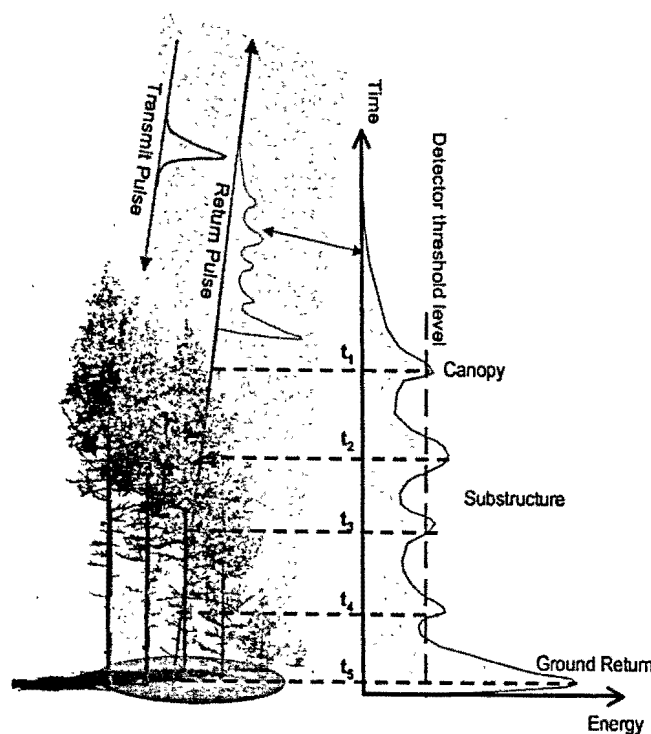
# Receiver Requirements



## Goal:

Generation 1: 1.06 $\mu$ m APD receivers with 200  $\mu$ m aperture, sensitivity < 100 fW/Hz<sup>1/2</sup> @ a bandwidth of 140 MHz

Generation 2: 1.06 $\mu$ m APD receivers with sensitivity < 300 fW/Hz<sup>1/2</sup> @ bandwidth of 1GHz



# Noise Equivalent Power Analysis

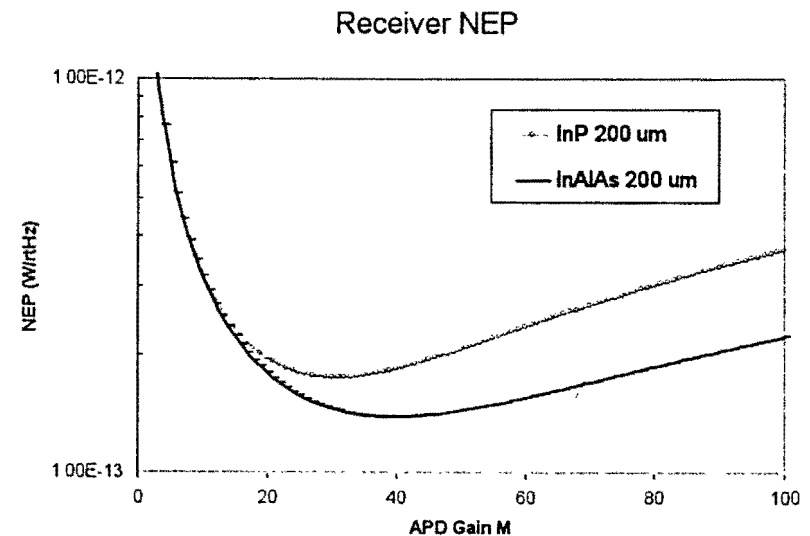
- APD + TIA Amp NEP

$$NEP = \frac{1}{R_{sp}} \left[ 2qI_d F + \frac{\alpha^2}{M^2} \right]^{1/2}$$

$$F = kM + \left( 2 - \frac{1}{M} \right) (1 - k)$$

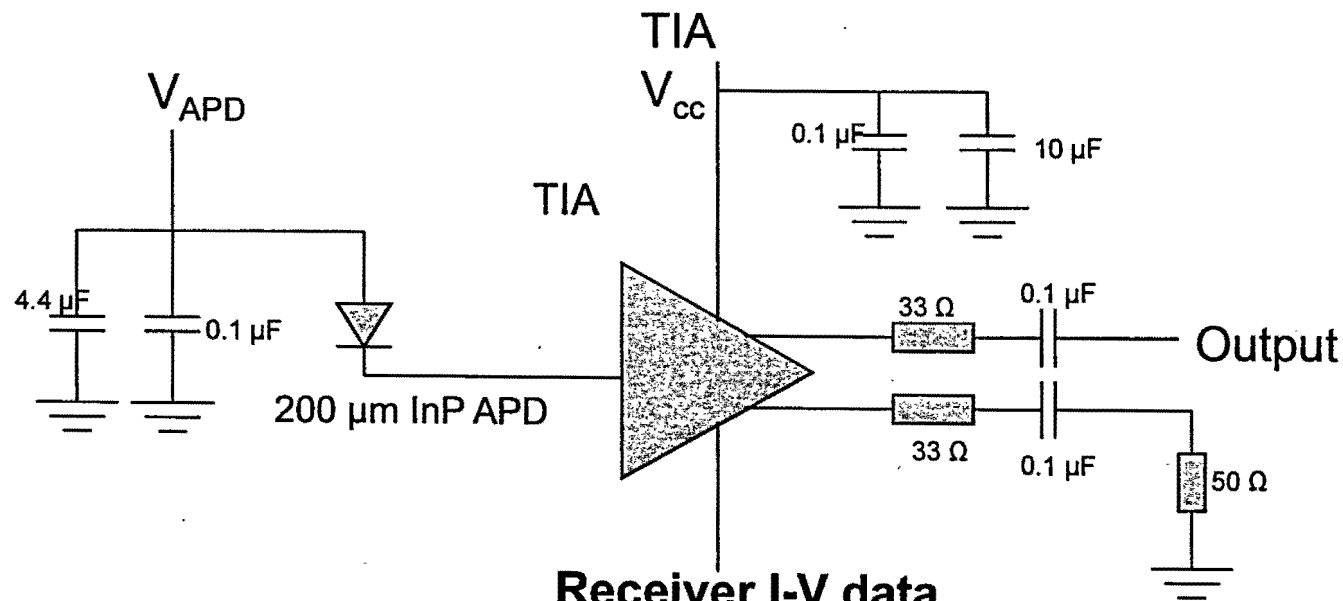
where  $R_{sp}$  is the APD unity gain responsivity,  $M$  is the APD optical gain,  $F$  is the APD excess noise factor,  $k$  is the ratio of the hole and electron ionization coefficients,  $\alpha$  is the TIA noise current density.

- Two critical parameters to reduce NEP
  - Excess noise factor  $k$
  - TIA noise current density  $\alpha$



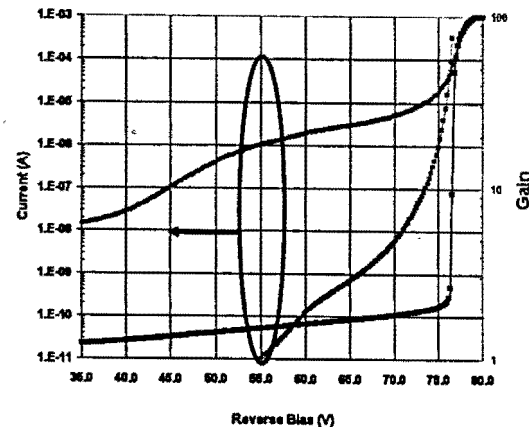
# Gen. 1 Photoreceiver Design

- 200  $\mu\text{m}$  InP APD
- Low noise TIA, SA5211 1.8  $\text{pA}/\text{Hz}^{1/2}$
- An integrated TEC cooler and a AD590 temperature sensor chip

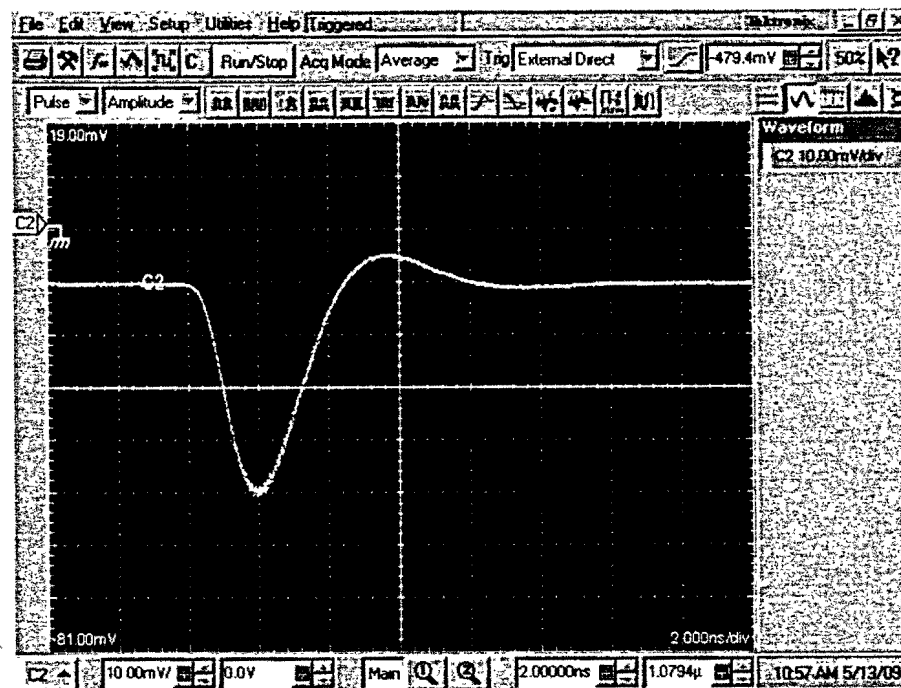
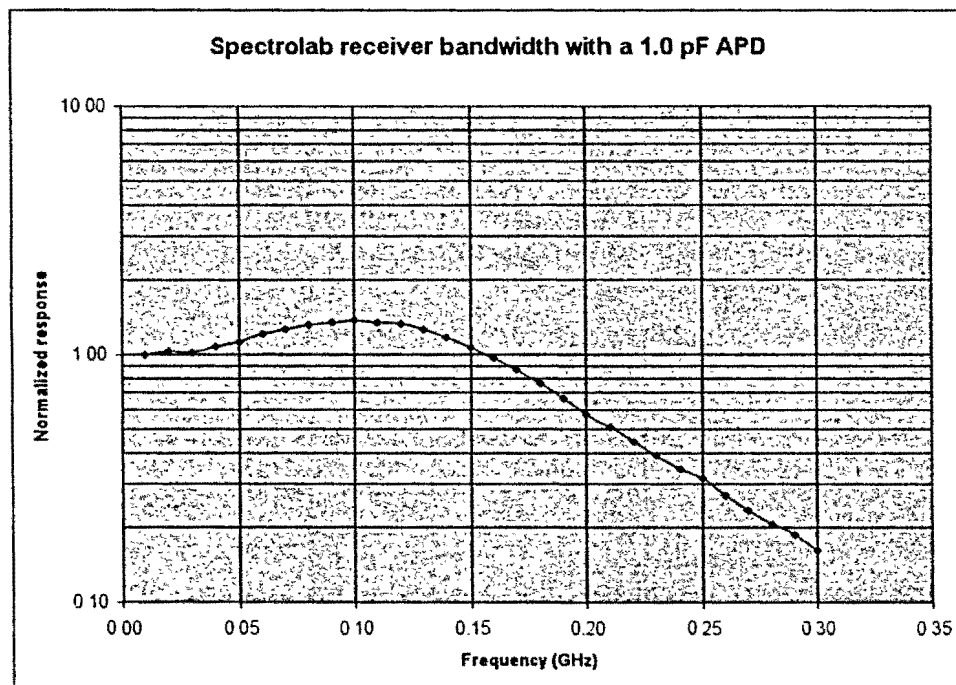


Receiver I-V data

9764-10 200 $\mu\text{m}$  APD



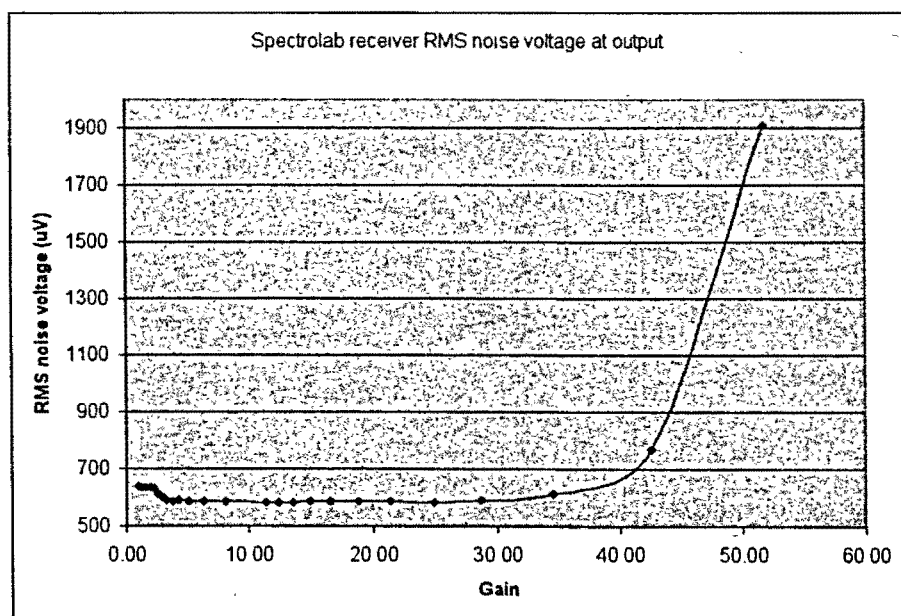
Receiver response to a 100ps 1.06 $\mu$ m laser pulse.



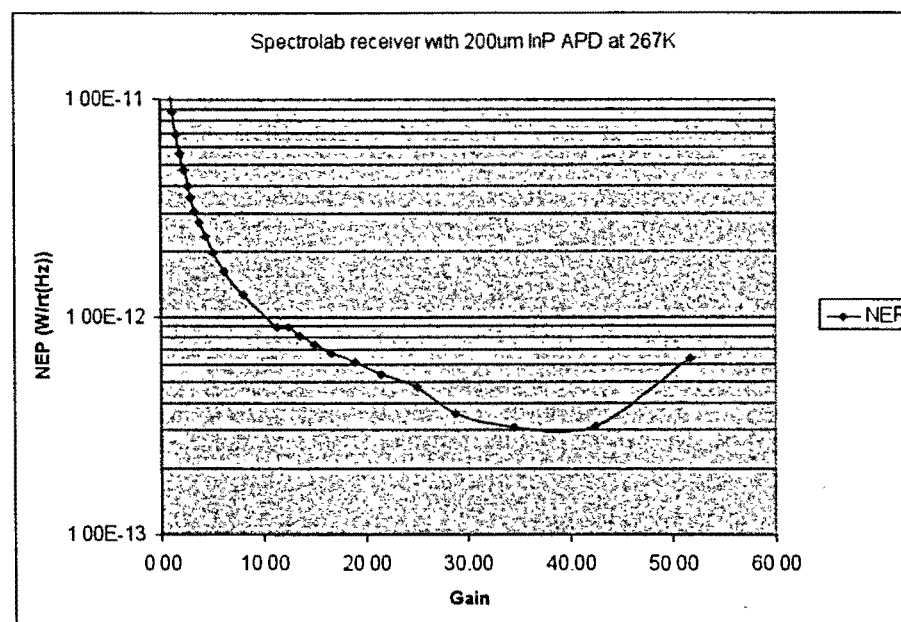
- Achieved bandwidth of 180 MHz

# Gen. 1 Photoreceiver NEP Data

## RMS Voltage Data



## NEP Data



- NEP < 300 fw/Hz<sup>1/2</sup> was achieved



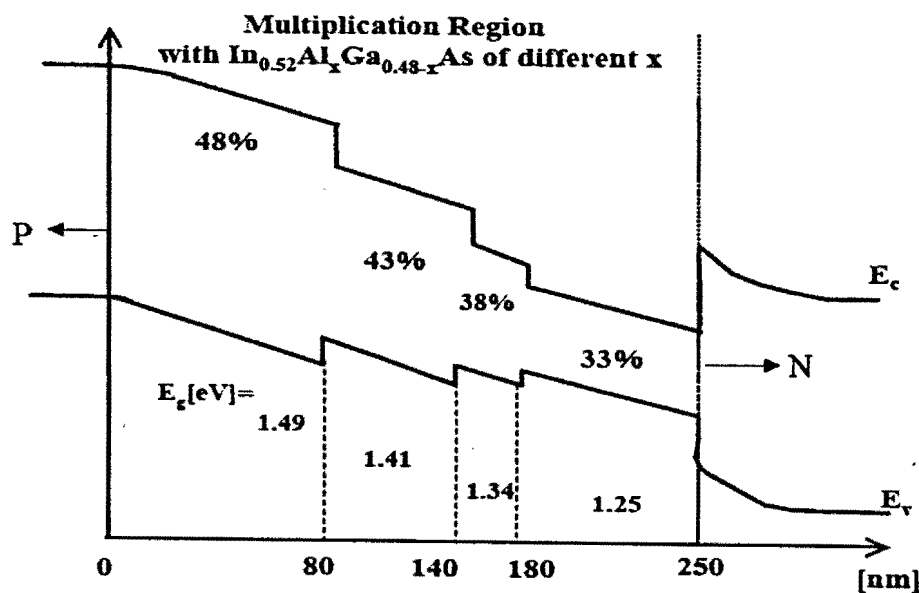
# Gen-2 Receiver Sensitivity Improvements

Goal:  $300 \text{ fW/Hz}^{1/2}$  @ bandwidth of 1GHz

- Quantum efficiency
  - Gen. 1 InP APD has 64% quantum efficiency
  - 75% QE will reduce NEP by 17%.
- Low noise TIAs
  - Select best low noise TIAs in die form with less than  $6 \text{ pA/Hz}^{1/2}$  input referred noise current.
- Reduce excess noise in APD
  - InAlAs has a  $k$  value  $\sim 0.22$
  - I<sup>2</sup>E APD design with reduced  $k_{\text{eff}} \leq 0.15$

- APDs have high internal gain and associate excess noise
- k factor is a material parameter for bulk material

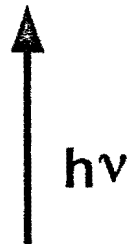
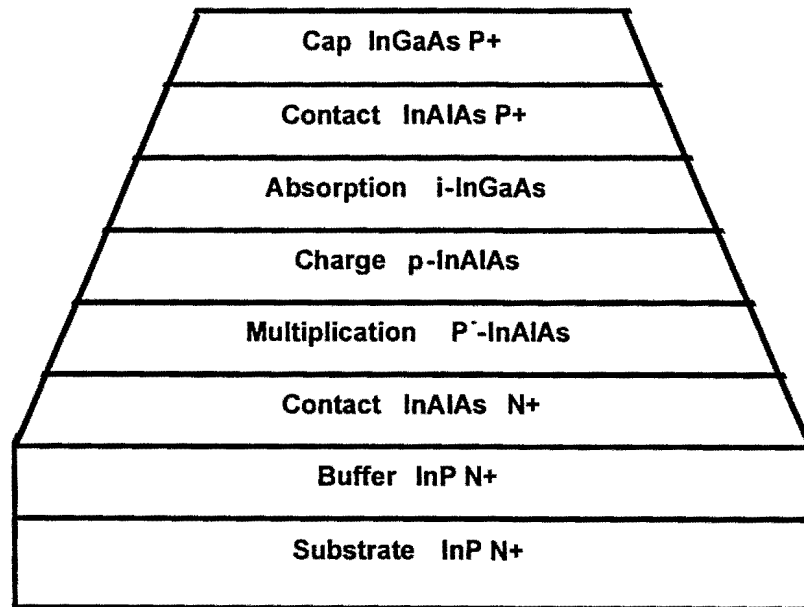
I<sup>2</sup>E= Impact Ionization Engineering



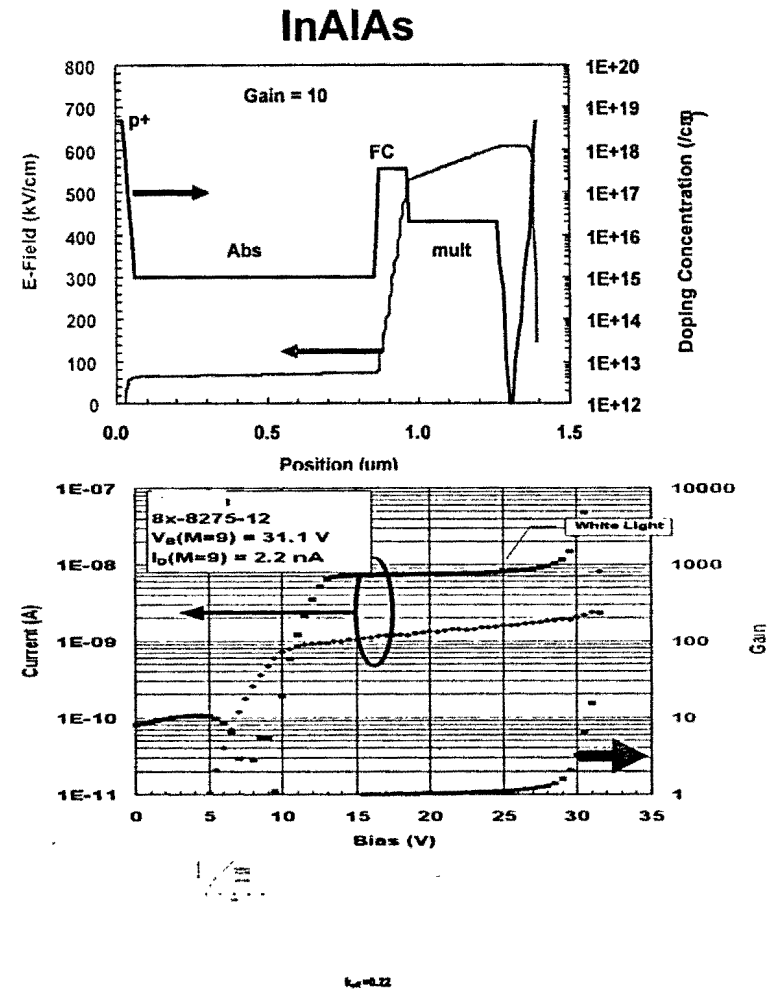
I<sup>2</sup>E is an approach to combine materials with different impact ionization threshold energies in the multiplication region. In the I<sup>2</sup>E structure, the avalanche events are more deterministic which result a low effective k-factor.

Graph from S. Wang, et. al., IEEE Photonics Technology Letters, Vol.14, No. 12, pg1722, 2002

## Spectrolab InAlAs APD



InAlAs APD shows  $k_{\text{eff}} = 0.22$



# Spectrolab I<sup>2</sup>E APD Design



---

p+ InGaAs Cap layer, 50nm

---

p+ InAlAs, 300nm

---

i-InGaAlAs Absorber  
1200nm  
E<sub>g</sub>~1.05 eV

---

p+, InAlAs Charge layer

---

I<sup>2</sup>E Multiplier

---

n+ InAlAs Buffer

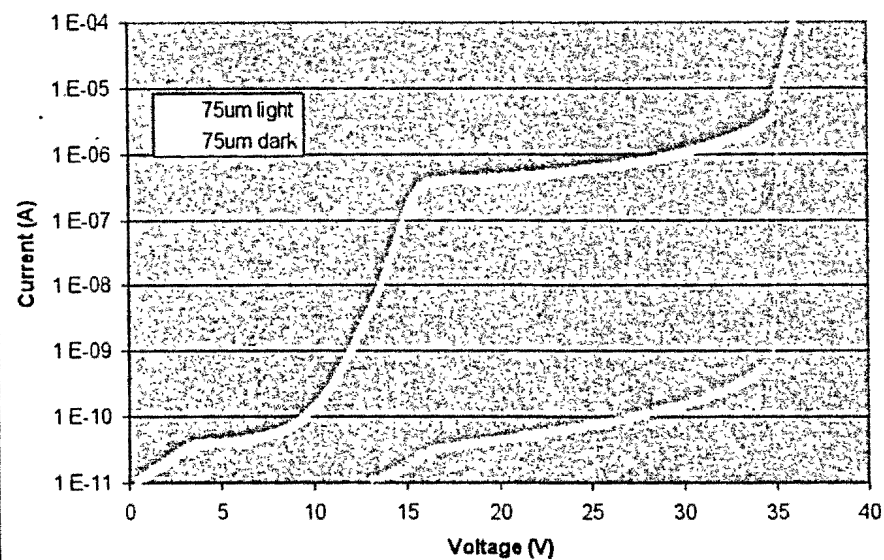
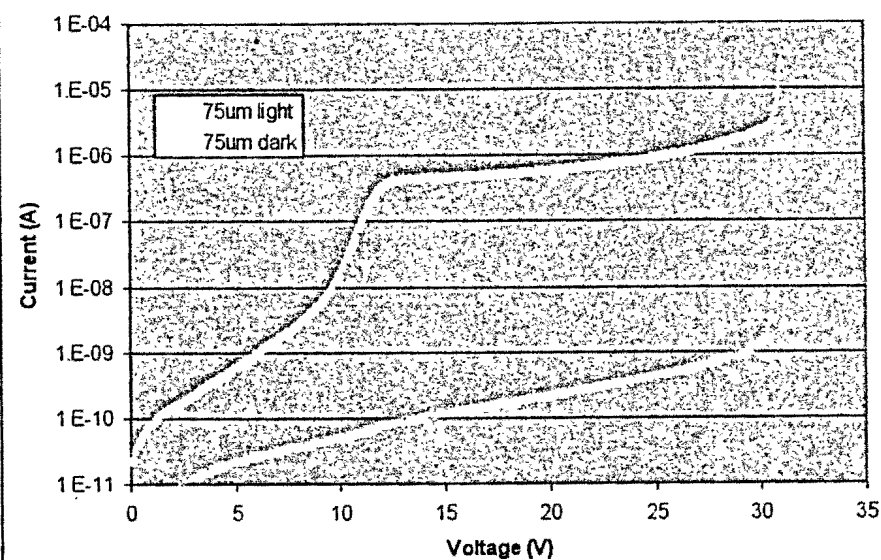
---

n+ InP Substrate

---

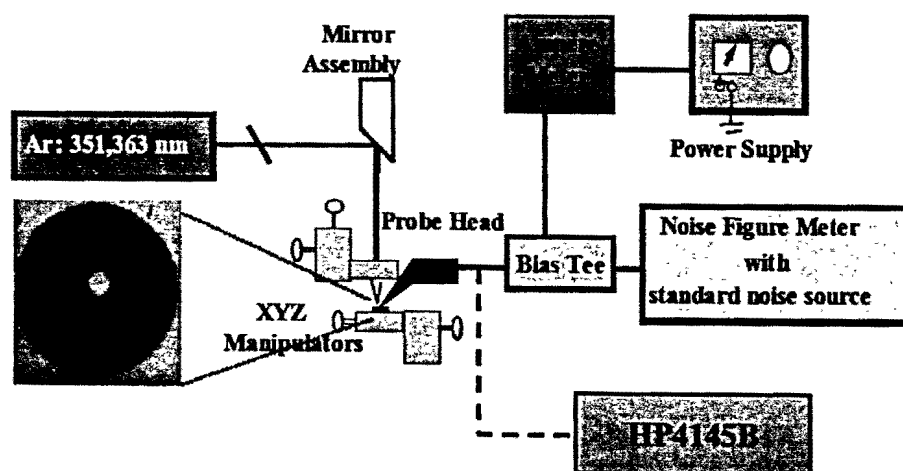
- InGaAlAs layer with bandgap of 1.2 eV is used as a multiplier

# I<sup>2</sup>E Device I-V Data

**Device A****Device B**

- Show very low dark current before breakdown.

# Excess Noise Measurement



$$S = 2eI_{\text{unity}} M^2 F(M) R(\omega)$$

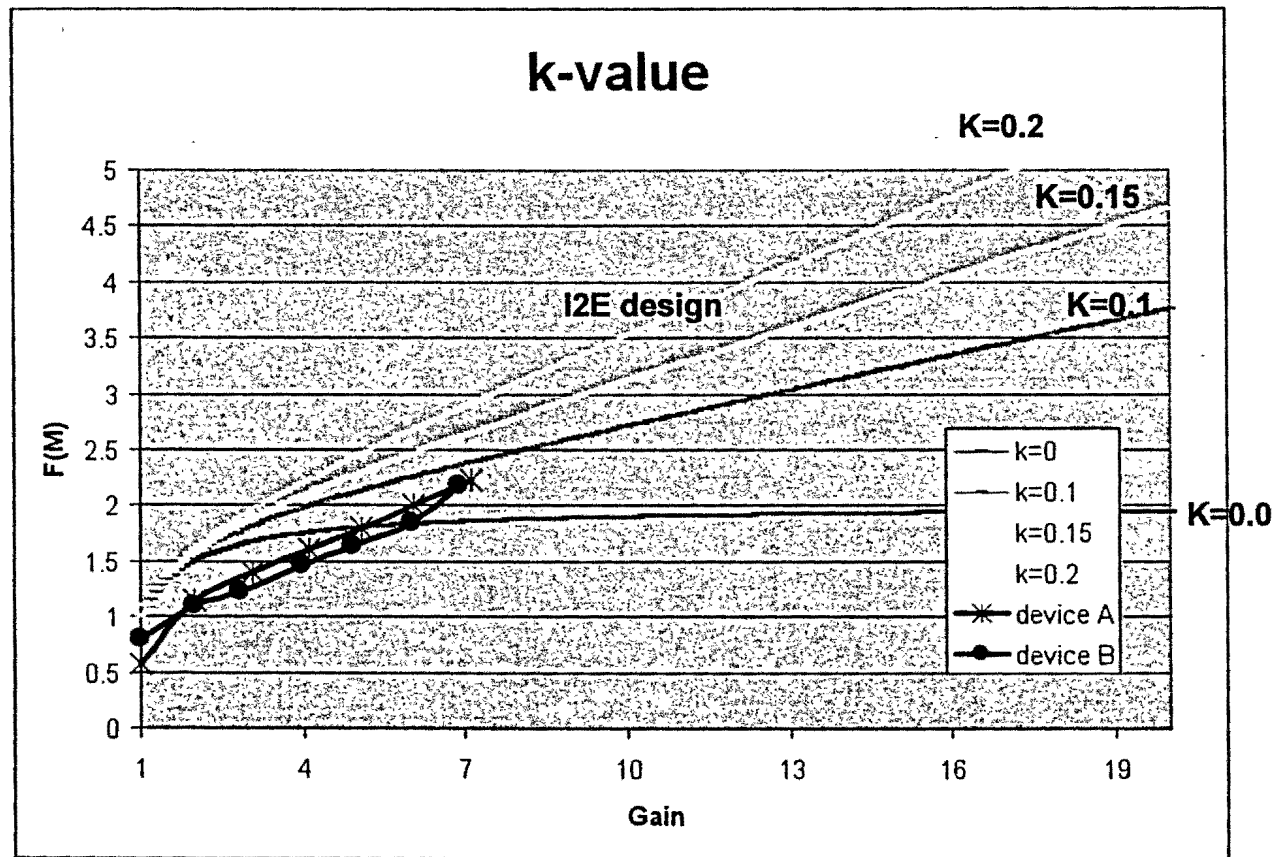
Testing procedure:

- (a) At unity gain, measure  $S$  vs.  $I_{\text{unity}}$  to fit the  $2eR(\omega)$ .
- (b) Measure  $S$  vs.  $M$  to get  $F(M)$ .

UV laser is absorbed near the surface p+ contact layer.  
Electrons are diffused into the multiplier, thus pure electron injection is realized.

\* Setup graph is from Dr. Shuling Wang's Ph. D. dissertation(2002).

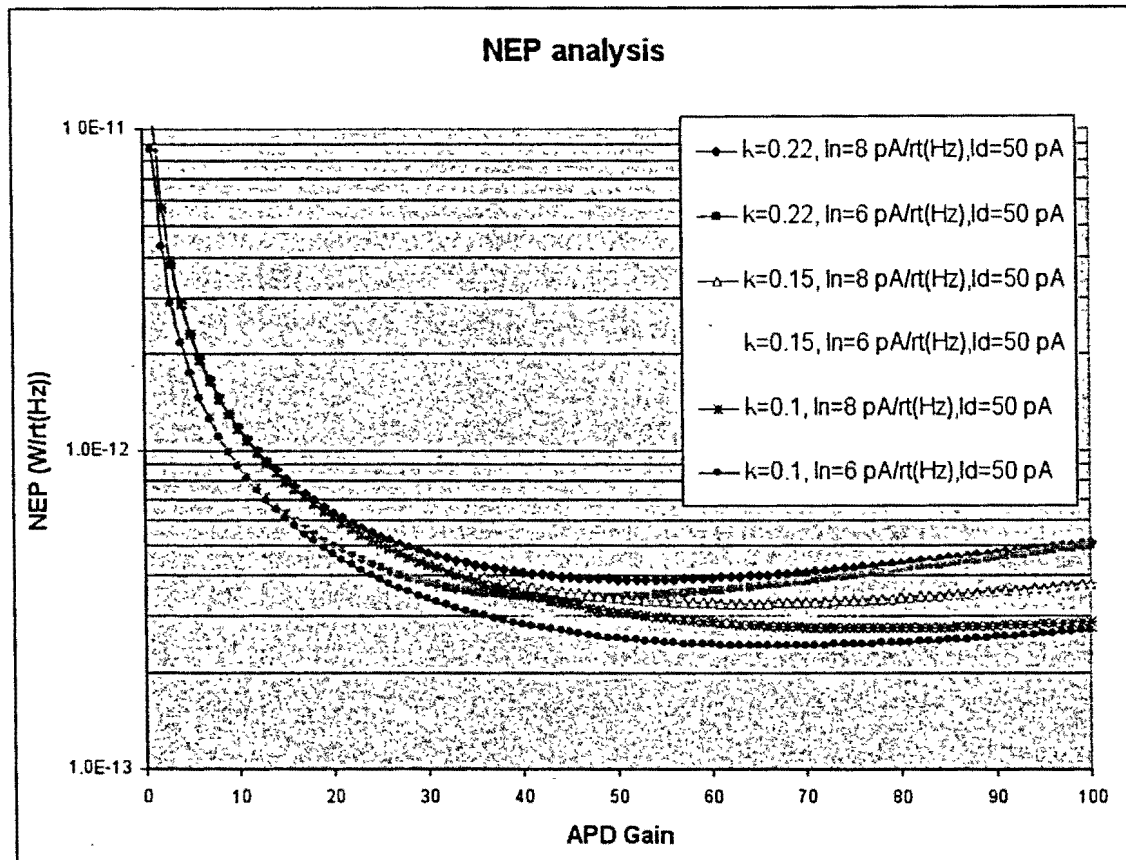
# Excess Noise Results



- Both device A and B show k value less than 0.1
- $k \leq 0.15$  is feasible at high gain (15~30) for future I<sup>2</sup>E

# Gen. 2 Photoreceiver – NEP BOEING

## Analysis



- NEP less than  $300 \text{ fW/Hz}^{1/2}$  over 1GHz bandwidth can be achieved using I<sup>2</sup>E devices



- Demonstrated NEP<300fw/Hz<sup>1/2</sup> photoreceiver using InP APD
- Developed InAlAs based I<sup>2</sup>E APDs
- Demonstrated low excess noise APDs, k<sub>eff</sub><0.1
- Developing Gen. 2 receiver with I<sup>2</sup>E APD devices to achieve NEP less than 300fw/Hz<sup>1/2</sup> over 1 GHz